

# **DRV591 PWM Power Driver Evaluation Module**

## User's Guide

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#### **EVM WARNINGS AND RESTRICTIONS**

It is important to operate this EVM within the supply voltage range of 2.8 V to 5.5 V.

Exceeding the specified supply range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the supply range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 125°C. The EVM is designed to operate properly with certain components above 125°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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### **Preface**

### How to Use This Manual

Thi	s document contains the following chapters:				
	Chapter 1—Introduction				
	Chapter 2—Operating Instructions				
Related Documentation From Texas Instruments					
	<b>DRV591</b> data sheet (literature number SLOS389).				

### FCC Warning

This equipment is intended for use in a laboratory test environment only. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to subpart J of part 15 of FCC rules, which are designed to provide reasonable protection against radio frequency interference. Operation of this equipment in other environments may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

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### **Chapter 1**

### Introduction

This chapter provides an overview of the Texas Instruments (TI) DRV591VFP high-efficiency power driver amplifier evaluation module. It includes a list of EVM features, a brief illustrated description of the module, and a list of EVM specifications.

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### 1.1 Feature Highlights

The	e DRV591VFP evaluation module includes the following features:
	PWM operation with full output filter
	High efficiency
	Small solution size
	Low supply current in active and shutdown modes
	LEDs and test points for fault monitoring
	Jumpers for selecting device options
	Easy connections for inputs, outputs, and power supply

### 1.2 Description

The DRV591VFP PWM power driver evaluation module is a complete power stage solution. It consists of the TI DRV591VFP PWM power driver IC along with a few discrete passive components required for operation. It also includes jumpers for configuring the features of the device, LEDs and test points for fault monitoring, and a full output filter that may be easily modified. The 5-way jacks for the inputs, outputs, and power supply provide for ease of connection to any system, from an existing design to a bread-boarded prototype.

### 1.3 EVM Specifications

Supply voltage range, V <sub>DD</sub>	2.8 V to 5.5 V
Supply current, I <sub>DD</sub>	3.1 A max

1-2 Introduction

### Chapter 2

### **Operating Instructions**

Follow the steps in this chapter to quickly prepare the DRV591VFP EVM for use.

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2.1	Precautions
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### 2.1 Precautions

**Power Supply Input Polarity and Maximum Voltage** 

Always ensure that the polarity and voltage of the external power connected  $V_{DD}$  power input connector J8 is correct. Overvoltage or reverse-polarity power applied to this terminal can damage the evaluation module.

### 2.2 Operating Instructions List

Figure 2–1. Top View

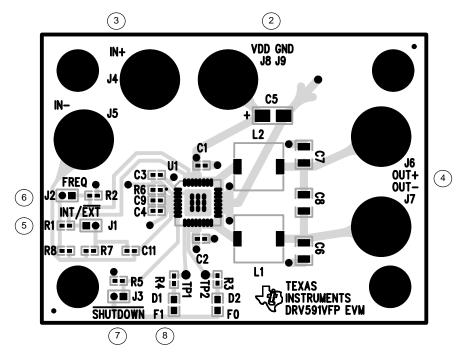


Table 2–1. Typical Jumper Settings

J1 (INT/EXT)	J2 (FREQ)	J3 (SHUTDOWN)	
ON	ON	ON	

### Power supply

- 1) Ensure that all external power sources are set to OFF.
- 2) Connect a 2.8-V to 5.5-V power supply to J8 ( $V_{DD}$ ) and J9 (GND), taking care to observe proper polarity.

### Inputs and outputs

 Connect a dc control voltage to J4 (IN+) ranging from ground to V<sub>DD</sub>. The terminal J5 (IN-) is held to V<sub>DD</sub>/2 with a resistor voltage divider, as shown in the schematic. Therefore, a dc control voltage of V<sub>DD</sub>/2 provides 0-V output from OUT+ to OUT-.

If a different bias or offset is required, the voltage divider resistors R1 and R2 may be replaced. The value of R1 and R2 in parallel should not exceed 1 k $\Omega$  to minimize gain error due to imbalance in the impedance of the differential input stage. Alternatively, the resistor divider may be removed and a different common voltage output (such as from an op-amp buffer or a power supply) may be connected to J5 (IN–).

#### Note:

The common mode input range of the DRV591VFP is 1.2 V to 3.8 V when using a 5-V supply, and 1.2 V to 2.1 V when using a 3.3-V supply. Refer to the DRV591 data sheet, TI literature number SLOS389.

4) Connect a load across J6 (OUT+) and J7 (OUT-). The polarity of the connection depends on the operation of the dc control voltage. As the voltage at IN+ becomes greater than the voltage at IN-, the voltage at OUT+ increases, causing current to flow from OUT+ to OUT-. Similarly, as the voltage at IN+ decreases lower than IN-, the voltage at OUT-increases, causing current to flow from OUT- to OUT+.

For example, consider the load to be a TEC element and the dc control voltage to be the output of a temperature control circuit. In this example, as temperature increases the output of the temperature control circuit increases. The TEC element should therefore be connected with the anode at OUT+ and the cathode at OUT- to ensure that the TEC element cools when the temperature increases.

### ■ Evaluation module jumpers, LEDs, and test points

- 5) Jumper J1 (INT/EXT) should be ON for normal operation.
  - When J1 is ON, the internal oscillator is used to generate the switching outputs. When J1 is OFF, an external TTL-compatible clock signal may be driven into the COSC pin of the DRV591VFP. The capacitor C9 must be removed and a wire may be soldered to the pad closest to the IC for connecting the external clock.
- 6) Jumper J2 (FREQ) should be ON for normal operation.
  - When J2 is ON, the device is configured for 500-kHz operation.
  - When J2 is OFF, the device is configured for 100-kHz operation. However, capacitor C9 must be removed and replaced with a 1-nF capacitor for proper operation.
- 7) Jumper J3 (SHUTDOWN) should be ON for normal operation. (Remove J1 to place the DRV591VFP in shutdown mode.)
  - If an external shutdown control signal is to be used, it should be connected to the right—hand pin of J1 (which is connected to resistor R3). The control signal must be TTL—compatible; a logic high provides normal operation, a logic low places the DRV591VFP in shutdown.

8) The LED D1 lights if FAULT1 is active and LED D2 lights if FAULT0 is active. If external fault monitoring is to be used, test point TP1 is connected to FAULT1 and test point TP2 is connected to FAULT0. The pins and test points go low when a fault is present, lighting the LEDs. The faults are shown in the table below. Refer to the DRV591 data sheet (SLOS389) for additional information on the fault indicators.

Table 2-2. Fault Indicators

FAULT1	FAULT0	
0	0	Overcurrent
1	0	Undervoltage
0	1	Overtemperature
1	1	Normal operation

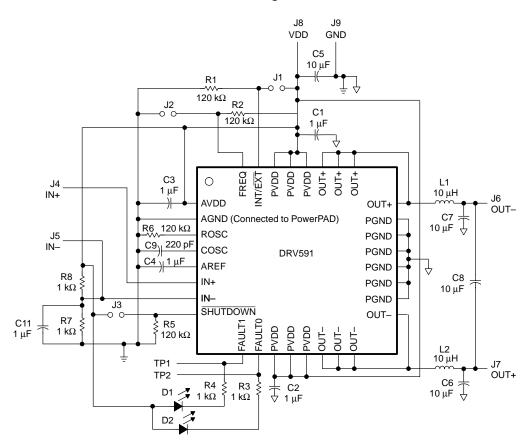
**Note:** 0 = LED ON (Fault) 1 = LED OFF (Normal)

#### ☐ Power up

Verify correct voltage, input polarity, and set the external power supply to ON. The EVM will begin operation.

#### 2.2.1 DRV591VFP EVM Schematic

Figure 2–2. DRV591VFP EVM Schematic Diagram



### 2.2.2 DRV591VFP EVM Bill of Materials

Table 2–3. DRV591VFP EVM Bill of Materials

Reference	Description	Size	Qty.	MFG	Part #	Vendor/#
C1–4, C11	Capacitor, ceramic, 1 μF, ±10%, X5R, 6.3 V	0603	5	Panasonic	ECJ1VB0J105K	Digi-Key/ PCC1915CT-ND
C5–C8	Capacitor, ceramic, 10 μF, ±10%, X5R, 16 V	1210	4	Panasonic	ECJ-4YB1C106K	Digi-Key/ PCC2169CT-ND
C9	Capacitor, ceramic, 220 pF, ±10%, X7R	0603	1	Panasonic	ECUV1J221KBV	Digi-Key/ PCC221BVCT-ND
C10	Capacitor (not assembled)					
R1, R2, R5, R6	Resistor, chip, 120 k $\Omega$ , 1/16 W, 1%	0603	4	Phycomp	9C06031A1203F KHFT	Digi-Key/ 311-120KHCT-ND
R3, R4, R7, R8	Resistor, chip, 1 k $\Omega$ , 1/16 W, 1%	0603	4	Phycomp	9C06031A1001F KHFT	Digi-Key/ 311-1.00KHCT-ND
D1, D2	LED, red, 2 V, 140° view angle	0805	2	Lumex	SML-LXT0805IW	Digi-Key/ 67–1552–2–ND
L1, L2	Inductor, SMT, 10 μH, 0.026 mΩ DCR (typical), 4.4 A max dc current		2	Sumida	CDRH104R-100	Harvey King/ CDRH104R-100
L3, L4	Chip bead (not assembled)	1806	2			
J1, J2, J3	Header, 2 position	2 mm	3	Norcomp	2163-2-01-P2	Digi-Key/ 2163S-02-ND
	Shunts	2 mm	3	3M	953170-00	Digi-Key/ 953170-00
TP1, TP2	Test points		2			Farnell/240-333
IN-, IN+, V <sub>DD</sub> , GND, OUT+, OUT- (J5-J9)	Uninsulated binding post with knurled thumb, nut-grounded type		6	Johnson Components	111-2223-001	Digi-Key/J587-ND
	Standoffs	4–40	4			Digi-Key/534-1804
U1	DRV591, 32-pin Quad Flatpack		1	TI	DRV591VFP	TI/DRV591VFP

### 2.2.3 DRV591VFP EVM PCB Layers

Figure 2–3. Top Layer

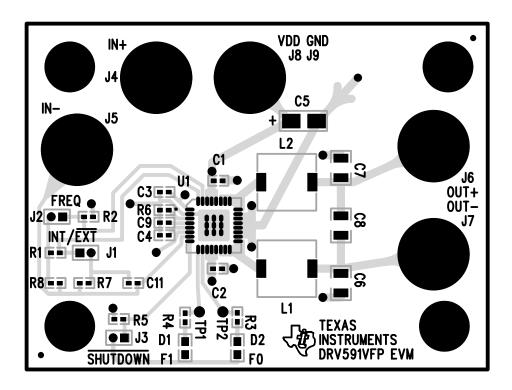


Figure 2-4. Bottom Layer

